

# IO-Link Master

## Protocol Test Report

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Test Report ID: TID-20210401-01  
Date: April 1<sup>st</sup> 2021  
Test performed by: Armin Otterstätter

Product: TI-PRU  
Vendor: Texas Instruments  
Vendor address: Dallas, Texas, US  
Device: TI-PRU IO-Link Master Driver  
HW Version: AM437X IDK EVM IO LINK Rev A + IDK2IOLME1-  
FW Version: from February 25<sup>th</sup> 2021

### Environment:

IDE: Code Composer Studio 8.1.0.00011  
XDCTools: 3.55.2.22\_core  
EDMA3 Low Level Driver: 2.12.5  
NDK: 3.61.1.01  
SYS/BIOS: 6.76.3.01  
am437x PDK: 1.0.17  
IO-Link Master Revision: 485  
Project-Code: svn://tmgsvn/1144\_TI\_PRU\_IO-Link Master/tags/ProtocolTest

IO-Link Interface Specification: IOL-Interface-Spec\_10002\_V112\_Jul13.pdf

IO-Link Test Specification: IOL-Test-Spec\_10032\_V112\_Jul14.pdf

The TMG TE GmbH as an accredited IO-Link Test Center declares that the above mentioned implementation complies with the essential requirements of the listed specifications.



Klaus-Peter Willems  
CEO / Head of IO-Link Test Center

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